



## SPECIFICATION FOR APPROVAL

**CUSTOMER** 

NOMINAL FREQUENCY

26.000000 MHz

**TYPE FH 2.5x2.0 SEAM SEALED CRYSTAL** 

SPEC. NO. (P/N)

PRODUCT TYPE

**CUSTOMER P/N** 

**ISSUE DATE** 

VERSION

FH2600037Q

January 19, 2018

С

APPROVED	PREPARED	QA
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#### **Diodes Incorporated**

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\*Pb-free

\*RoHS Compliant

- \*HF-Halogen Free
- **\*REACH Compliant**
- \*AEC-Q200 Compliant

#### FH2600037Q

VER. C 19-Jan-18

## **VERSION HISTORY**

Version No.	Version Date	Description	Notes
A	Mar.18,2015	Initial Release	
В	Apr.20,2015	Updated Frequency Stability to ±45ppm & Operating Temperature Range to -40~125°C	
С	Jan.19,2018	Updated logo	



#### FH2600037Q

VER. C 19-Jan-18

#### **ELECTRICAL SPECIFICATIONS**

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	26.000000	MHz	
Mode of Oscillation	MO	AT Cut-Fundamental		
Calibration Load Capacitance	CL	10	pF	
Calibration Tolerance	FL	±10	ppm	at 25°C±3°C
Operating Temperature Range	TR	-40 to +125	°C	
Frequency Stability (Frequency Deviation over the Operating Temperature Range)	F/T	±45	ppm	Reference to the Frequency at 25°C
Operating Drive Level		100	μW	
Maximum Drive Level		200	μW	
Equivalent Series Resistance	ESR	80	Ω	Мах
Shunt Capacitance	C0	5	pF	Мах
Aging at 25°C		±3	ppm	Max, 1st year
Storage Temperature		-55 to +125	°C	
Insulation Resistance		500	MΩ	Min

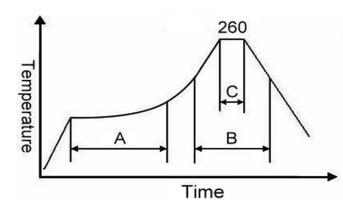
\* This product doesn't include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).



#### FH2600037Q

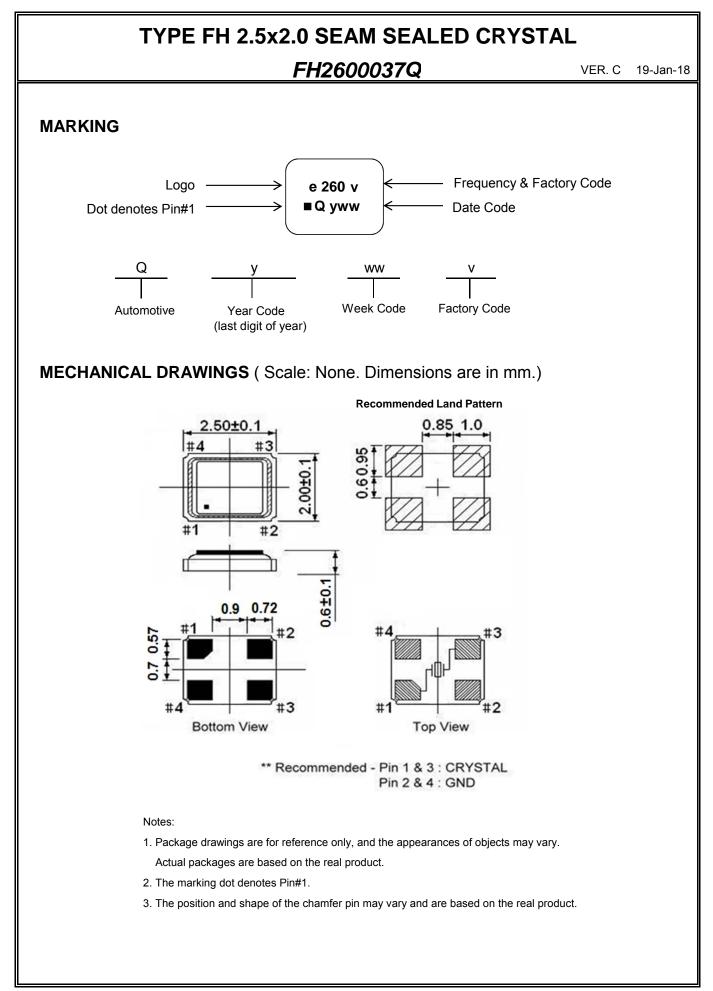
## **AEC-Q200 RELIABILITY TEST SPECIFICATIONS:** 1. Initial 1.1 Physical Dimensions: JESD22, Method JB1-100 1.2 External Visual: MIL-STD-883, Method 2009 1.3 Freq. Vs. Temperature: Per Specification/Datasheet 2. Mechanical 2.1 Mechanical Shock: MIL-STD-202 Method 213 2.2 Vibration: MIL-STD-202 Method 204 2.3 Solderability: J-STD-002 2.4 Board Flex: AEC Q200-005 2.5 Terminal Strength (SMD): AEC Q200-006 3.Environmental 3.1 Temp Cycle: JESD22, Method JA-104 3.2 Resistance to Solder Heat: MIL-STD-202 Method 210 3.3 High Temperature Operating Life: MIL-STD-202, Method 108 3.4 High Temp Exposure: MIL-STD-202, Method 108 3.5 High Temp & High Humidity: MIL-STD-202, Method 103 3.6 Thermal Shock: MIL-STD-202, Method 107 SUGGESTED IR REFLOW PROFILE

\*As per IPC-JEDEC J-STD-020D



Note:								
	Stage	Temperature	Time					
А	Preheat	150~200°C	60~120 Sec					
в	Primary Heat	217°C	60~150 Sec					
С	Peak	260°C	10 Sec					



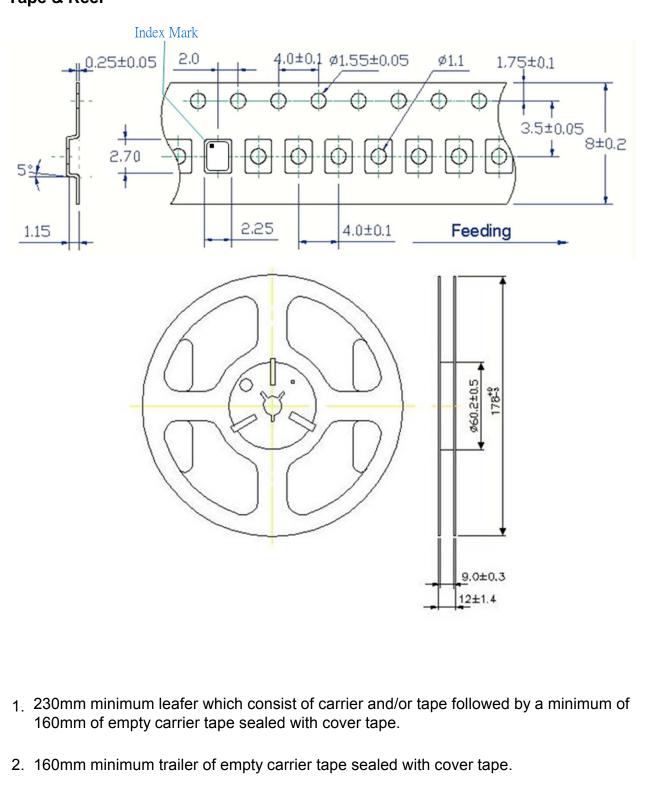




#### FH2600037Q

VER. C 19-Jan-18

Tape & Reel





# **TYPE FH 2.5x2.0 SEAM SEALED CRYSTAL** FH2600037Q VER. C 19-Jan-18 PACKING Begin Start End 3000pcs-Product Tape rensena como como como como como como de la Δ Inner Packing Carton 0 Blue Qualified Label Storeroom Label Δ. Storeroom Label Storeroom Label Deliver Packing Carton (L29\*W24\*H30) Green Qualified Label

